## BCR3AS-12B

## Triac

## Low Power Use

(The product guaranteed maximum junction temperature of $150^{\circ} \mathrm{C}$ )

## Features

- $\mathrm{I}_{\mathrm{T}(\mathrm{RMS})}: 3 \mathrm{~A}$
- $\mathrm{V}_{\mathrm{DRM}}: 600 \mathrm{~V}$
- $\mathrm{I}_{\mathrm{FGT}}, \mathrm{I}_{\text {RGT }}, \mathrm{I}_{\text {RGT III }}: 15 \mathrm{~mA}$


## Outline <br> outine

RENESAS Package code: PRSS0004ZA-A
(Package name: MP-3A)

1. $\mathrm{T}_{1}$ Terminal
2. $\mathrm{T}_{2}$ Terminal
3. Gate Terminal
4. $\mathrm{T}_{2}$ Terminal

5. T2 Terminal

- Non-Insulated Type
- Planar Passivation Type



## Applications

Hybrid IC, solid state relay, switching mode power supply, light dimmer, electric fan, electric blanket, control of household equipment such as washing machine, and other general purpose control applications

## Warning

1. Refer to the recommended circuit values around the triac before using.
2. Be sure to exchange the specification before using. Otherwise, general triacs with the maximum junction temperature of $125^{\circ} \mathrm{C}$ will be supplied.

## Maximum Ratings

| Parameter | Symbol | Voltage class | Unit |
| :--- | :---: | :---: | :---: |
|  |  | 12 |  |
| Repetitive peak off-state voltage ${ }^{\text {Note1 }}$ | $\mathrm{V}_{\text {DRM }}$ | 600 | V |
| Non-repetitive peak off-state voltage ${ }^{\text {Note1 }}$ | $\mathrm{V}_{\text {DSM }}$ | 720 |  |

BCR3AS-12B (The product guaranteed maximum junction temperature of $150^{\circ} \mathrm{C}$ )

| Parameter | Symbol | Ratings | Unit | Conditions |
| :--- | :---: | :---: | :---: | :--- |
| RMS on-state current | $\mathrm{I}_{\mathrm{T}(\mathrm{RMS})}$ | 3 | A | Commercial frequency, sine full wave <br> $360^{\circ}$ conduction, $\mathrm{Tc}=133^{\circ} \mathrm{C}^{\text {Note3 }}$ |
| Surge on-state current | $\mathrm{I}_{\mathrm{TSM}}$ | 30 | A | 60 Hz sinewave 1 full cycle, peak value, <br> non-repetitive |
| $\mathrm{I}^{2} \mathrm{t}$ for fusing | $\mathrm{I}^{2} \mathrm{t}$ | 3.7 | $\mathrm{~A}^{2} \mathrm{~S}$ | Value corresponding to 1 cycle of half <br> wave 60 Hz, surge on-state current |
| Peak gate power dissipation | $\mathrm{P}_{\mathrm{GM}}$ | 3 | W |  |
| Average gate power dissipation | $\mathrm{P}_{\mathrm{G}(\mathrm{AV})}$ | 0.3 | W |  |
| Peak gate voltage | $\mathrm{V}_{\mathrm{GM}}$ | 6 | V |  |
| Peak gate current | $\mathrm{I}_{\mathrm{GM}}$ | 0.3 | A |  |
| Junction temperature | Tj | -40 to +150 | ${ }^{\circ} \mathrm{C}$ |  |
| Storage temperature | Tstg | -40 to +150 | ${ }^{\circ} \mathrm{C}$ |  |
| Mass | - | 0.26 | g | Typical value |

Notes: 1. Gate open.
Electrical Characteristics

| Parameter |  | Symbol | Min. | Typ. | Max. | Unit | Test conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Repetitive peak off-state current |  | $\mathrm{I}_{\text {DRM }}$ | - | - | 2.0 | mA | $\mathrm{Tj}=150^{\circ} \mathrm{C}, \mathrm{V}_{\text {DRM }}$ applied |
| On-state voltage |  | $\mathrm{V}_{\text {TM }}$ | - | - | 1.7 | V | $\mathrm{Tc}=25^{\circ} \mathrm{C}, \mathrm{I}_{\mathrm{TM}}=4.5 \mathrm{~A},$ <br> Instantaneous measurement |
| Gate trigger voltage ${ }^{\text {Note2 }}$ | I | $\mathrm{V}_{\text {FGT I }}$ | - | - | 1.5 | V | $\begin{aligned} & \mathrm{Tj}=25^{\circ} \mathrm{C}, \mathrm{~V}_{\mathrm{D}}=6 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=6 \Omega, \\ & \mathrm{R}_{\mathrm{G}}=330 \Omega \end{aligned}$ |
|  | II | $\mathrm{V}_{\text {RGT }}$ | - | - | 1.5 | V |  |
|  | III | $\mathrm{V}_{\text {RGT III }}$ | - | - | 1.5 | V |  |
| Gate trigger current ${ }^{\text {Note2 }}$ | I | $\mathrm{I}_{\mathrm{FGT} \mathrm{I} \text { I }}$ | - | - | 15 | mA | $\begin{aligned} & \mathrm{Tj}=25^{\circ} \mathrm{C}, \mathrm{~V}_{\mathrm{D}}=6 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=6 \Omega, \\ & \mathrm{R}_{\mathrm{G}}=330 \Omega \end{aligned}$ |
|  | II | $\mathrm{I}_{\text {RGT I }}$ | - | - | 15 | mA |  |
|  | III | $\mathrm{I}_{\text {RGT III }}$ | - | - | 15 | mA |  |
| Gate non-trigger voltage |  | $\mathrm{V}_{\mathrm{GD}}$ | 0.2/0.1 | - | - | V | $\begin{aligned} & \mathrm{Tj}=125^{\circ} \mathrm{C} / 150^{\circ} \mathrm{C}, \\ & \mathrm{~V}_{\mathrm{D}}=1 / 2 \mathrm{~V}_{\text {DRM }} \end{aligned}$ |
| Thermal resistance |  | $\mathrm{R}_{\mathrm{th}(\mathrm{j}-\mathrm{c})}$ | - | - | 3.8 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ | Junction to case ${ }^{\text {Note3 }}$ |
| Critical-rate of rise of off-state commutating voltage ${ }^{\text {Note4 }}$ |  | (dv/dt)c | 5/1 | - | - | V/us | $\mathrm{Tj}=125^{\circ} \mathrm{C} / 150^{\circ} \mathrm{C}$ |

Notes:
2. Measurement using the gate trigger characteristics measurement circuit.
3. Case temperature is measured on the $T_{2}$ tab.
4. Test conditions of the critical-rate of rise of off-state commutating voltage is shown in the table below.

| Test conditions | Commutating voltage and current waveforms <br> (inductive load) |
| :--- | :---: |
| 1. Junction temperature <br> $\mathrm{Tj}=125^{\circ} \mathrm{C} / 150^{\circ} \mathrm{C}$ <br> 2. Rate of decay of on-state commutating current <br> (di/dt)c $=-1.5 \mathrm{~A} / \mathrm{ms}$ <br> 3. Peak off-state voltage <br> $\mathrm{V}=400 \mathrm{~V}$ | Supply Voltage |

## Performance Curves





Gate Trigger Characteristics Test Circuits


Test Procedure I

Test Procedure III


Recommended Circuit Values Around The Triac

$\begin{array}{ll}\mathrm{C}_{1}=0.1 \text { to } 0.47 \mu \mathrm{~F} & \mathrm{C}_{0}=0.1 \mu \mathrm{~F} \\ \mathrm{R}_{1}=47 \text { to } 100 \Omega & \mathrm{R}_{0}=100 \Omega\end{array}$

## Package Dimensions



## Order Code

| Lead form | Standard packing | Quantity | Standard order code | Standard order <br> code example |
| :--- | :--- | ---: | :--- | :--- |
| Surface-mounted type | Taping | 3000 | Type name - T +Direction (1 or 2) +3 | BCR3AS-12B-T13 |
| Surface-mounted type | Plastic Magazine <br> (Tube) | 75 | Type name | BCR3AS-12B |

Note : Please confirm the specification about the shipping in detail.

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